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MOSFET – Power, Single **N-Channel**

40 V, 1.1 mΩ, 268 A

NVMFS5C420N

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFS5C420NWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant



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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
40 V	1.1 mΩ @ 10 V	268 A

D (5,6) Q

Parameter Drain-to-Source Voltage			Symbol	Value	Unit V
			V _{DSS}	40	
Gate-to-Source Voltage			V _{GS}	±20	V
Continuous Drain	Steady State	$T_C = 25^{\circ}C$	I _D	268	А
Current R _{θJC} (Notes 1, 3)		T _C = 100°C		190	
Power Dissipation $R_{\theta JC}$ (Note 1)		T _C = 25°C	PD	150	W
		$T_{C} = 100^{\circ}C$		75	
Continuous Drain Current R _{θJA} (Notes 1, 2, 3)	Steady State	T _A = 25°C	I _D	43	А
		T _A = 100°C		30	
Power Dissipation $R_{\theta JA}$ (Notes 1, 2)		$T_A = 25^{\circ}C$	PD	3.8	W
		$T_A = 100^{\circ}C$		1.9	
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \ \mu s$		I _{DM}	900	А
Operating Junction and Storage Temperature Range			T _J , T _{stg}	–55 to +175	°C
Source Current (Body Diode)			۱ _S	125	А
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 24 A)			E _{AS}	1541	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

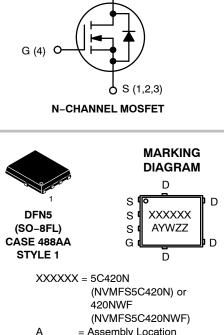
THERMAL RESISTANCE MAXIMUM RATINGS

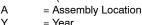
Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	1.0	°C/W
Junction-to-Ambient - Steady State (Note 2)	R _{0.1A}	39	

The entire application environment impacts the thermal resistance values shown, 1. they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.







W = Work Week 77

= Lot Traceability

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

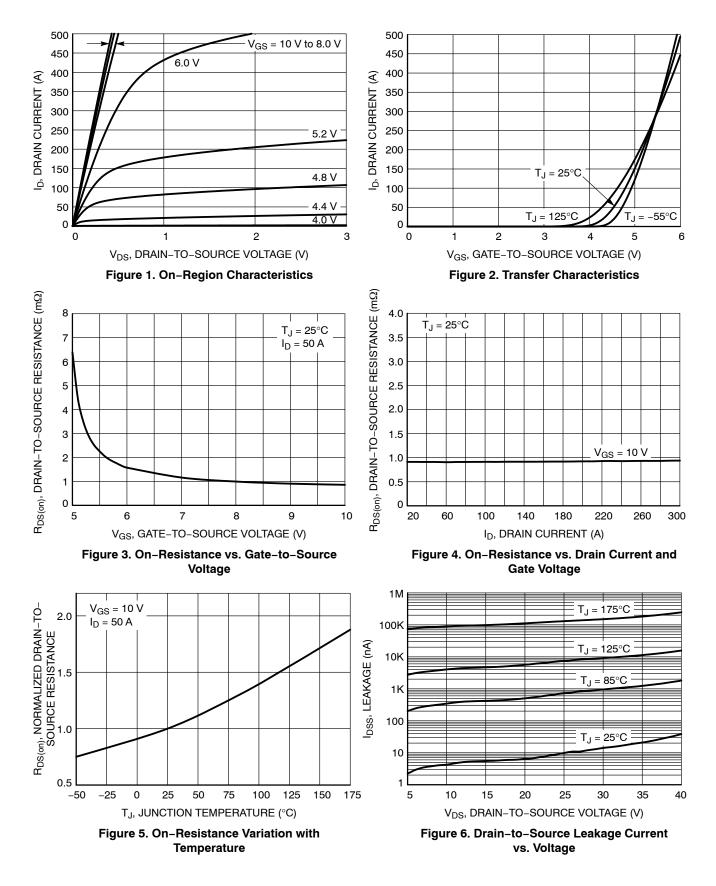
ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit	
OFF CHARACTERISTICS							•	
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 µA		40			V	
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				20		mV/°C	
Zero Gate Voltage Drain Current	I _{DSS}	I_{DSS} $V_{GS} = 0 V$, $T_J = 25 °C$				10		
		$V_{DS} = 40 V$	T _J = 125°C			100	μΑ	
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{GS} = 20 V$				100	nA	
ON CHARACTERISTICS (Note 4)								
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS}=V_{DS},I_{D}=200\;\mu A$		2.0		4.0	V	
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-7.7		mV/°C	
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	l _D = 50 A		0.9	1.1	mΩ	
Forward Transconductance	9 _{FS}	V _{DS} = 5 V, I _D = 50 A			161		S	
CHARGES, CAPACITANCES & GATE RE	SISTANCE							
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 20 V			5340		pF	
Output Capacitance	C _{OSS}				3500			
Reverse Transfer Capacitance	C _{RSS}				140			
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 32 V; I _D = 50 A			82			
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 10 V, V _{DS} = 32 V; I _D = 50 A			5.3		nC	
Gate-to-Source Charge	Q _{GS}				21			
Gate-to-Drain Charge	Q _{GD}				23			
Plateau Voltage	V _{GP}				4.7		V	
SWITCHING CHARACTERISTICS (Note 5	5)			-	-			
Turn-On Delay Time	t _{d(ON)}				22			
Rise Time	tr	V_{GS} = 10 V, V_{DS} = 32 V, I_{D} = 50 A, R_{G} = 2.5 Ω			19		ns	
Turn-Off Delay Time	t _{d(OFF)}				54			
Fall Time	t _f				20			
DRAIN-SOURCE DIODE CHARACTERIS	TICS				•		•	
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$		0.8	1.2		
	$I_{\rm S} = 50 \rm A$	T _J = 125°C		0.65		~ ~		
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dIS/dt = 100 A/µs, I _S = 50 A			113		ns	
Charge Time	ta				52			
Discharge Time	t _b				61			
Reverse Recovery Charge	Q _{RR}				236		nC	

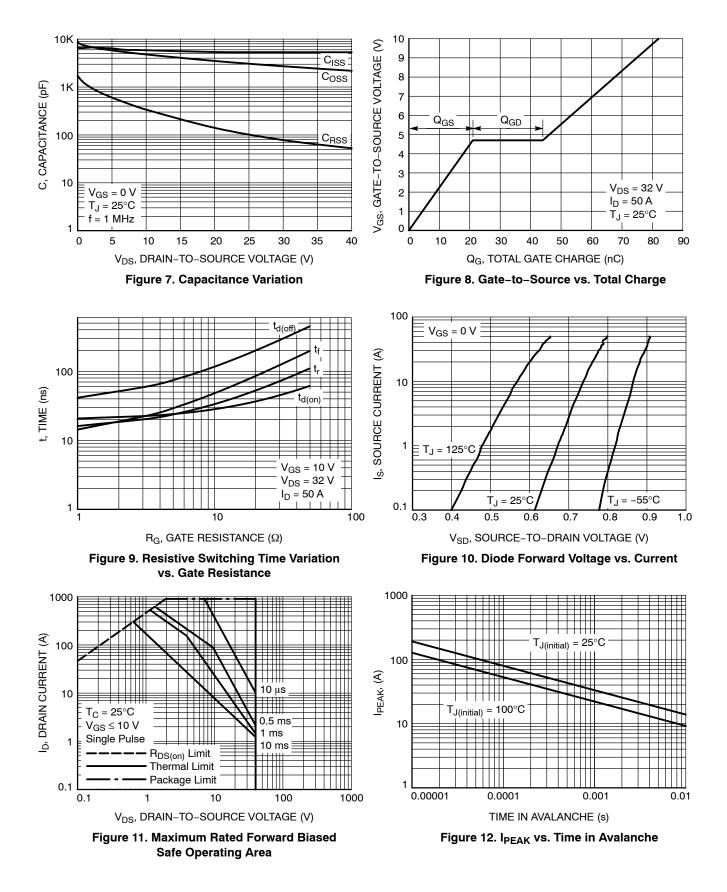
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$.

5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

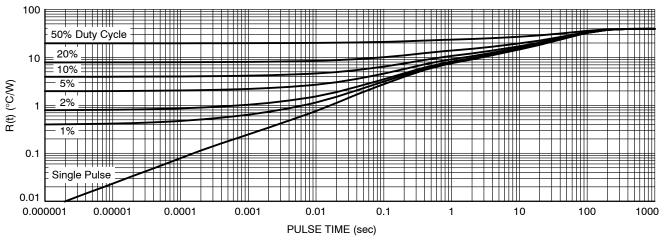


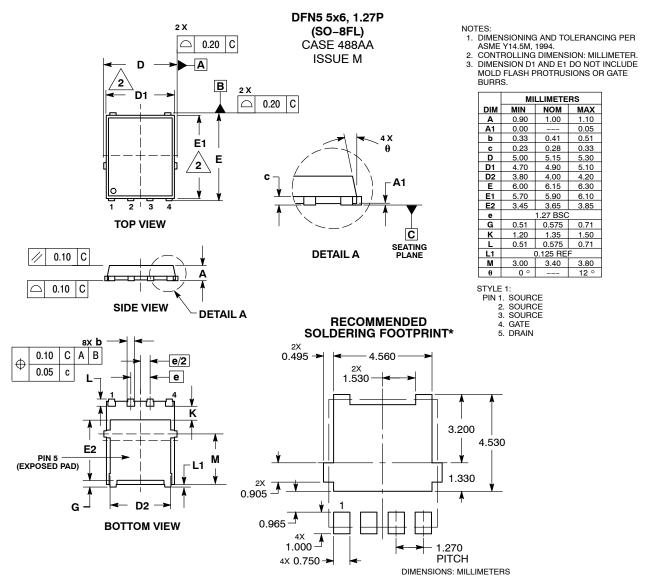
Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NVMFS5C420NT1G	5C420N	DFN5 (Pb–Free)	1500 / Tape & Reel
NVMFS5C420NWFT1G	420NWF	DFN5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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